### INTEGRATED CIRCUITS

# DATA SHEET

## 74ABT16541 74ABTH16541

16-bit buffer/line driver (3-State)

Product specification Supersedes data of 1995 Sep 18 IC23 Data Handbook





## 16-bit buffer/line driver (3-State)

### 74ABT16541 74ABTH16541

#### **FEATURES**

- Power-up 3-State
- Multiple V<sub>CC</sub> and GND pins minimize switching noise
- Provides ideal interface and increases fan-out of MOS Microprocessors
- 3-State buffers sink 64mA and source 32mA
- 74ABTH16541 incorporates bus-hold data inputs which eliminate the need for external pull-up resistors to hold unused inputs
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model
- Two 8-bit bus interfaces
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs

#### **DESCRIPTION**

The 74ABT16541 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT16541 has two octal buffers that are ideal for driving bus lines. The outputs are all capable of sinking 64mA and sourcing 32mA

Two options are available, 74ABT16541 which does not have the bus-hold feature and 74ABTH16541 which incorporates the bus-hold feature.

#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS T <sub>amb</sub> = 25°C; GND = 0V	TYPICAL	UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay nAx to nYx	$C_L = 50pF; V_{CC} = 5V$	2.0 1.5	ns
C <sub>IN</sub>	Input capacitance	$V_I = 0V$ or $V_{CC}$	4	pF
C <sub>OUT</sub>	Output capacitance	V <sub>O</sub> = 0V or V <sub>CC</sub> ; 3-State	6	pF
I <sub>CCZ</sub>	Quiescent supply current	Outputs disabled; V <sub>CC</sub> =5.5V	500	μΑ
I <sub>CCL</sub>	- Quiescent supply current	Outputs LOW; V <sub>CC</sub> = 5.5V	8	mA

#### **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
48-Pin Plastic SSOP Type III	–40°C to +85°C	74ABT16541 DL	BT16541 DL	SOT370-1
48-Pin Plastic TSSOP Type II	–40°C to +85°C	74ABT16541 DGG	BT16541 DGG	SOT362-1
48-Pin Plastic SSOP Type III	–40°C to +85°C	74ABTH16541 DL	BH16541 DL	SOT370-1
48-Pin Plastic TSSOP Type II	–40°C to +85°C	74ABTH16541 DGG	BH16541 DGG	SOT362-1

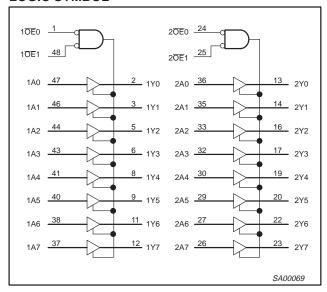
#### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION
47, 46, 44, 43, 41, 40, 38, 37, 36, 35, 33, 32, 30, 29, 27, 26	1A0 - 1A7 2A0 - 2A7	Data inputs
2, 3, 5, 6, 8, 9, 11, 12, 13, 14, 16, 17 19, 20, 22, 23	1Y0 - 1Y7, 2Y0 - 2Y7	Data outputs
1, 48 24, 25	1 <u>OE</u> 0, 1 <u>OE</u> 1, 2 <u>OE</u> 0, 2 <u>OE</u> 1	Output enables
4, 10, 15, 21 28, 34, 39, 45	GND	Ground (0V)
7, 18, 31, 42	V <sub>CC</sub>	Positive supply voltage

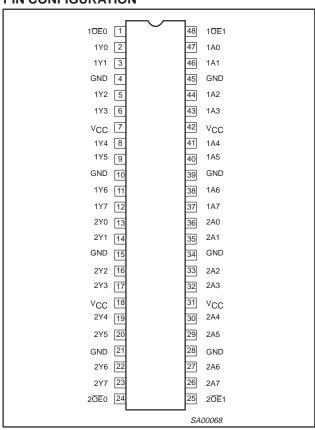
## 16-bit buffer/line driver (3-State)

74ABT16541 74ABTH16541

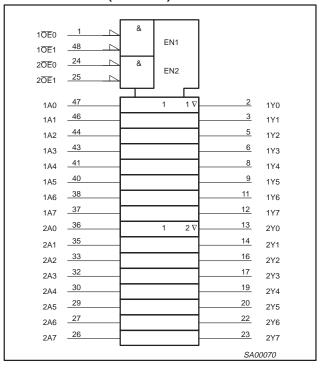
#### **LOGIC SYMBOL**



#### **PIN CONFIGURATION**



#### LOGIC SYMBOL (IEEE/IEC)



#### **FUNCTION TABLE**

	INPUTS									
nOE0	n <del>OE</del> 1	nlx	nYx							
L	L	L	L							
L	L	Н	Н							
Х	Н	Х	z							
Н	Х	Х	Z							

= HIGH voltage level = LOW voltage level

= D0n't care

= High impedance "off" state

## 16-bit buffer/line driver (3-State)

74ABT16541 74ABTH16541

#### **ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>**

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V
I <sub>IK</sub>	DC input diode current	V <sub>I</sub> < 0	-18	mA
VI	DC input voltage <sup>3</sup>		-1.2 to +7.0	V
I <sub>OK</sub>	DC output diode current	V <sub>O</sub> < 0	-50	mA
V <sub>OUT</sub>	DC output voltage <sup>3</sup>	output in Off or High state	-0.5 to +5.5	V
I <sub>OUT</sub>	DC output current	output in Low state	128	mA
T <sub>stg</sub>	Storage temperature range		-65 to 150	°C

#### NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
   The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
   The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	LIM	ITS	UNIT
STWIBUL	PARAMETER	Min	Max	UNII
V <sub>CC</sub>	DC supply voltage	4.5	5.5	V
VI	Input voltage	0	V <sub>CC</sub>	V
V <sub>IH</sub>	High-level input voltage	2.0		V
V <sub>IL</sub>	Low-level Input voltage		0.8	V
I <sub>OH</sub>	High-level output current		-32	mA
I <sub>OL</sub>	Low-level output current		64	mA
Δt/Δν	Input transition rise or fall rate	0	10	ns/V
T <sub>amb</sub>	Operating free-air temperature range	-40	+85	°C

## 16-bit buffer/line driver (3-State)

74ABT16541 74ABTH16541

#### DC ELECTRICAL CHARACTERISTICS

						LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	S	Ta	<sub>mb</sub> = +25	°C	T <sub>amb</sub> =	–40°C 35°C	UNIT
			Min	Тур	Max	Min	Max		
V <sub>IK</sub>	Input clamp voltage	$V_{CC} = 4.5V; I_{IK} = -18mA$		-0.9	-1.2		-1.2	V	
		$V_{CC} = 4.5V; I_{OH} = -3mA; V_{I} = V$	2.5	2.9		2.5		V	
$V_{OH}$	High-level output voltage	$V_{CC} = 5.0V; I_{OH} = -3mA; V_{I} = V$	<sub>IL</sub> or V <sub>IH</sub>	3.0	3.4		3.0		V
		$V_{CC} = 4.5V; I_{OH} = -32mA; V_{I} = -32mA$	V <sub>IL</sub> or V <sub>IH</sub>	2.0	2.4		2.0		V
V <sub>OL</sub>	Low-level output voltage	$V_{CC} = 4.5V; I_{OL} = 64mA; V_{I} = V$	$V_{CC} = 4.5V$ ; $I_{OL} = 64$ mA; $V_I = V_{IL}$ or $V_{IH}$					0.55	٧
lį	Input leakage current	$V_{CC} = 5.5V; V_I = GND \text{ or } 5.5V$			±0.01	±1.0		±1.0	μА
	Input leakage current	$V_{CC} = 5.5V$ ; $V_I = V_{CC}$ or GND	Control pins		±0.01	±1		±1	μА
I <sub>I</sub>	74ABTH16541	V <sub>CC</sub> = 5.5V; V <sub>I</sub> = V <sub>CC</sub>	Data pins		0.01	1		1	μΑ
		$V_{CC} = 5.5V; V_I = 0$	Data piris		-2	-3		<b>-</b> 5	μΑ
	B . H.H	$V_{CC} = 4.5V; V_I = 0.8V$	50			50			
$I_{HOLD}$	Bus Hold current A inputs <sup>3</sup> 74ABTH16541	$V_{CC} = 4.5V; V_I = 2.0V$	-75			<del>-7</del> 5		μΑ	
		$V_{CC} = 5.5V$ ; $V_I = 0$ to 5.5V	±500						
I <sub>OFF</sub>	Power-off leakage current	$V_{CC} = 0.0V$ ; $V_O$ or $V_I \le 4.5V$			±5.0	±100		±100	μΑ
I <sub>PU</sub> /I <sub>PD</sub>	Power-up/down 3-State output current	$V_{CC} = 2.0V; V_O = 0.5V; V_I = GN$ $V_{OE} = V_{CC}$	ID or V <sub>CC</sub> ;		±5.0	±50		±50	μА
I <sub>OZH</sub>	3-State output High current	$V_{CC} = 5.5V; V_{O} = 2.7V; V_{I} = V_{IL}$	or V <sub>IH</sub>		1.0	10		10	μА
I <sub>OZL</sub>	3-State output Low current	$V_{CC} = 5.5V; V_{O} = 0.5V; V_{I} = V_{IL}$	or V <sub>IH</sub>		-1.0	-10		-10	μΑ
I <sub>CEX</sub>	Output high leakage current	$V_{CC} = 5.5V; V_O = 5.5V; V_I = GN$	ID or V <sub>CC</sub>		1.0	50		50	μΑ
Io	Output current <sup>1</sup>	$V_{CC} = 5.5V; V_O = 2.5V$		-50	-70	-180	-50	-180	mA
I <sub>CCH</sub>		$V_{CC}$ = 5.5V; Outputs High, $V_{I}$ =	GND or V <sub>CC</sub>		0.5	1.0		1.0	mA
I <sub>CCL</sub>	Quiescent supply current	$V_{CC} = 5.5V$ ; Outputs Low, $V_I = 0$	$V_{CC} = 5.5V$ ; Outputs High, $V_{I} = GND$ or $V_{CC}$ $V_{CC} = 5.5V$ ; Outputs Low, $V_{I} = GND$ or $V_{CC}$					19	mA
I <sub>CCZ</sub>		V <sub>CC</sub> = 5.5V; Outputs 3-State; V <sub>I</sub> = GND or V <sub>CC</sub>		0.5	1.0		1.0	mA	
Δl <sub>CC</sub>	Additional supply current per input pin <sup>2</sup> 74ABT16541	Outputs enabled, one input at 3 inputs at $V_{CC}$ or GND; $V_{CC} = 5$ .			100	250		250	μΑ
$\Delta I_{CC}$	Additional supply current per input pin <sup>2</sup> 74ABTH16541	Outputs enabled, one input at 3 inputs at V <sub>CC</sub> or GND; V <sub>CC</sub> = 5.	,		0.2	1.0		1.0	mA

- NOTES:

  1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

  2. This is the increase in supply current for each input at 3.4V.

  3. This is the bus hold overdrive current required to force the input to the opposite logic state.

#### **AC CHARACTERISTICS**

GND = 0V;  $t_R = t_F$  = 2.5ns;  $C_L$  = 50pF,  $R_L$  = 500 $\Omega$ 

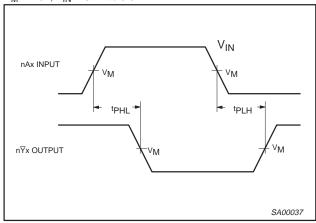
					LIMIT	rs		
SYMBOL	PARAMETER	WAVEFORM	T <sub>2</sub> V	<sub>amb</sub> = +25° CC = +5.0°	C V	T <sub>amb</sub> = -40° V <sub>CC</sub> = +5.	UNIT	
			Min	Тур	Max	Min	Max	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay nlx to nYx	1	1.0 1.0	2.0 1.5	3.0 3.6	1.0 1.0	3.4 4.2	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output enable time to High and Low level	2	1.3 1.6	2.9 3.1	4.3 4.7	1.3 1.6	5.2 6.0	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output disable time from High and Low level	2	1.3 1.0	3.5 2.8	4.4 3.6	1.3 1.0	5.1 3.9	ns

## 16-bit buffer/line driver (3-State)

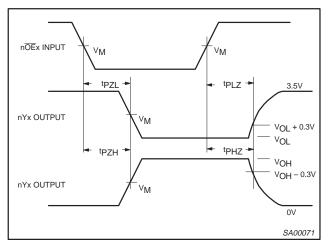
74ABT16541 74ABTH16541

#### **AC WAVEFORMS**

 $V_M = 1.5V$ ,  $V_{IN} = GND$  to 3.0V

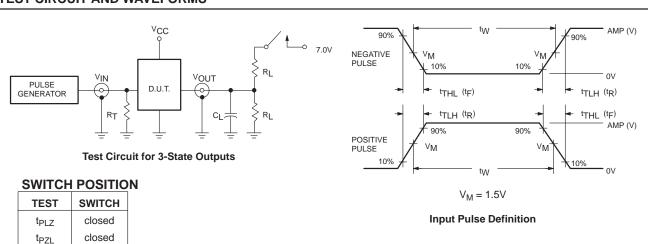


Waveform 1. Input (An) to Output (Yn) Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

#### **TEST CIRCUIT AND WAVEFORMS**



#### **DEFINITIONS**

open

All other

 $R_L$  = Load resistor; see AC CHARACTERISTICS for value.

C<sub>L</sub> = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

 $R_T = Termination resistance should be equal to <math>Z_{OUT}$  of pulse generators.

FAMILY	IN	INPUT PULSE REQUIREMENTS										
FAMILY	Amplitude	Rep. Rate	t <sub>W</sub>	t <sub>R</sub>	t <sub>F</sub>							
74ABT	3.0V	1MHz	500ns	2.5ns	2.5ns							

SA00012

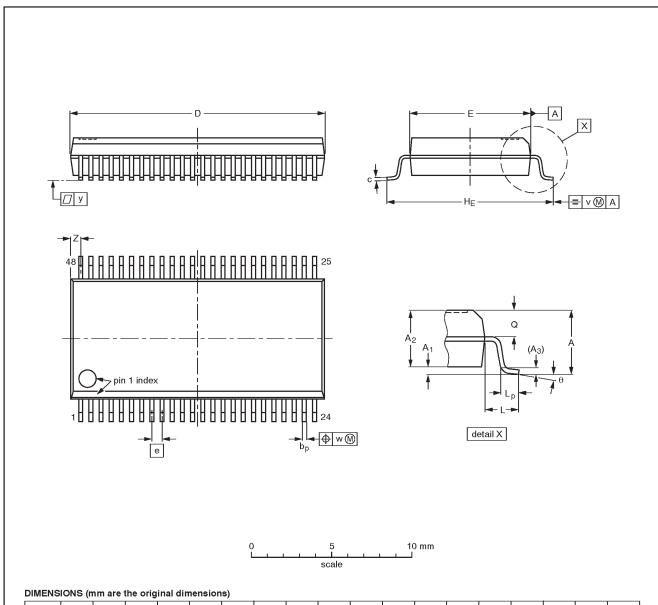
1998 Feb 25 6

## 16-bit buffer/line driver (3-State)

74ABT16541 74ABTH16541

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



	(.					,												
UNIT	. A max.	Α1	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	16.00 15.75	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES		EUROPEAN	ISSUE DATE	
VERSION	VERSION IEC JEDEC EIAJ				PROJECTION	ISSUE DATE	
SOT370-1		MO-118AA				<del>93-11-02</del> 95-02-04	

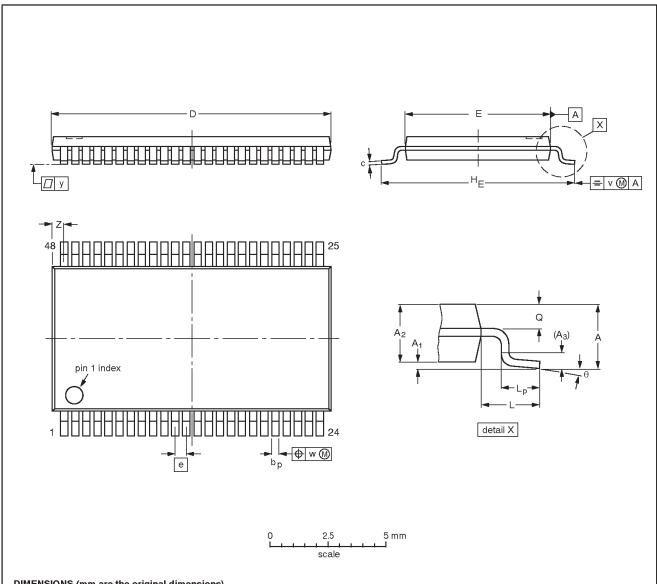
1998 Feb 25 7

## 16-bit buffer/line driver (3-State)

74ABT16541 74ABTH16541

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1mm

SOT362-1



#### DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	А3	bр	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	12.6 12.4	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.8 0.4	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES					EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ			PROJECTION	ISSUE DATE
SOT362-1		MO-153ED					<del>-93-02-03</del> 95-02-10

## 16-bit buffer/line driver (3-State)

74ABT16541 74ABTH16541

**NOTES** 

1998 Feb 25 9

### 16-bit buffer/line driver (3-State)

74ABT16541 74ABTH16541

#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development.  Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date.  Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

#### **Definitions**

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Application information** — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

#### **Disclaimers**

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Philips Semiconductors 811 East Arques Avenue P.O. Box 3409 Sunnyvale, California 94088–3409 Telephone 800-234-7381 © Copyright Philips Electronics North America Corporation 1998 All rights reserved. Printed in U.S.A.

print code Date of release: 05-96

Document order number: 9397-750-03495

Let's make things better.

Philips Semiconductors



